

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	6470862
<b>Application Number:</b>	10540513
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	6641
<b>Title of Invention:</b>	Compound semiconductor epitaxial substrate and method for manufacturing the same
<b>First Named Inventor/Applicant Name:</b>	Takenori Osada
<b>Customer Number:</b>	23373
<b>Filer:</b>	Abraham Jacob Rosner/Kamila Williams
<b>Filer Authorized By:</b>	Abraham Jacob Rosner
<b>Attorney Docket Number:</b>	Q88662
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<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		Q88662_IDS.pdf	116915 4c901ab769a685471ec60dca1b0dfaaf53ac2472	yes	4

	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Transmittal Letter		1	2	
	Transmittal Letter		3	3	
	Information Disclosure Statement (IDS) Filed (SB/08)		4	4	
Warnings:					
Information:					
2	NPL Documents	Q88662_OA_pdf.pdf	545513	no	6
			c99e4ee4e4b541f8e81adda69ccb95c5612540a4		
Warnings:					
Information:					
3	Foreign Reference	Q88662_JP609_pdf.pdf	1689923	no	9
			9206ac87f4f6e78ca4b0fea01b4e64cc4b6d343e		
Warnings:					
Information:					
4	Foreign Reference	Q88662_JP413_pdf.pdf	1006448	no	7
			7f6eb1e57c12e1399ad42398bfeaab267f279cf7		
Warnings:					
Information:					
5	Foreign Reference	Q88662_JP819_pdf.pdf	1792533	no	9
			f96cc82a2dc734736b888f06483a530638e08b97		
Warnings:					
Information:					
Total Files Size (in bytes):			5151332		

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**If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.**

**National Stage of an International Application under 35 U.S.C. 371**

**If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.**

**New International Application Filed with the USPTO as a Receiving Office**

**If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.**